

### SIDACtor® Series - DO-15



#### Agency Approvals

Agency	Agency File Number
	E133083

#### Pinout Designation

Not Applicable

#### Schematic Symbol



#### Description

The DO-15 series are designed to protect baseband equipment such as modems, line cards, CPE and DSL from damaging overvoltage transients.

The series provides a cost-effective through-hole solution that enables equipment to comply with global regulatory standards.

#### Features and Benefits

- Low voltage overshoot
- Low on-state voltage
- Does not degrade surge capability after multiple surge events within limit.
- Low capacitance
- Fails short circuit when surged in excess of ratings
- 2nd level interconnect is Pb-free per IPC/ JEDEC J-STD-609A.01
- RoHS compliant, lead-free and halogen-free.

#### Applicable Global Standards

- TIA-968-A
- TIA-968-B
- ITU K.20/21/45 Enhanced Level\*
- ITU K.20/21/45 Basic Level
- GR 1089 Inter-building\*
- GR 1089 Intra-building
- IEC 61000-4-5 2nd edition
- YD/T 1082
- YD/T 993
- YD/T 950

\* A/B-rated parts require series resistance

#### Electrical Characteristics

Part Number	Marking	$V_{DRM}$	$V_S$	$I_H$	$I_S$	$I_T$	$V_T$	Capacitance	
		@ $I_{DRM}=5\mu A$	@ 100V/ $\mu s$	mA min	mA max	A max	@ $I_T=2.2$ Amps	@ 1MHz, 2V bias	
		V min	V max				V max	pF min	pF max
P0080GALRP	P-8A	6	25	50	800	2.2	4	10	30
P1100GALRP	P11A	90	130	150	800	2.2	5	30	60
P1300GALRP	P13A	120	160	150	800	2.2	5	25	40
P1500GALRP	P15A	140	180	150	800	2.2	5	25	40
P1800GALRP	P18A	170	220	150	800	2.2	5	25	40
P2300GALRP	P23A	190	260	150	800	2.2	5	25	30
P2600GALRP	P26A	220	300	150	800	2.2	5	25	30
P3100GALRP	P31A	275	350	150	800	2.2	5	10	20
P3500GALRP	P35A	320	400	150	800	2.2	5	20	30
P1100GBLRP	P11B	90	130	150	800	2.2	5	30	60
P1300GBLRP	P13B	120	160	150	800	2.2	5	25	40
P1500GBLRP	P15B	140	180	150	800	2.2	5	25	40
P1800GBLRP	P18B	170	220	150	800	2.2	5	25	40
P2300GBLRP	P23B	190	260	150	800	2.2	5	25	30
P2600GBLRP	P26B	220	300	150	800	2.2	5	25	30
P3100GBLRP	P31B	275	350	150	800	2.2	5	20	30
P3500GBLRP	P35B	320	400	150	800	2.2	5	20	30
P4500GBLRP	P45B	400	530	150	800	2.2	5	20	45
P4500GCLRP	P45C	400	530	50	800	2.2	5	20	45

Notes:  
 - Absolute maximum ratings measured at  $T_A = 25^\circ C$  (unless otherwise noted).  
 - Components are bi-directional.

### Surge Ratings

Series	$I_{PP}$			$I_{TSM}$
	10/560 <sup>1</sup> 10/560 <sup>2</sup>	10/1000 <sup>1</sup> 10/1000 <sup>2</sup>	5/310 <sup>1</sup> 10/700 <sup>2</sup>	50 / 60 Hz
	Amps min	Amps min	Amps min	Amps min
A	50	45	-	20
B	100	80	100	25
C	-	-	150	25

Notes:

1 Current waveform in  $\mu s$

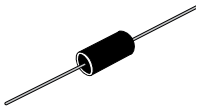
2 Voltage waveform in  $\mu s$

- Peak pulse current rating ( $I_{PP}$ ) is repetitive and guaranteed for the life of the product that remains in thermal equilibrium.

-  $I_{PP}$  ratings applicable over temperature range of -40 to +85°C

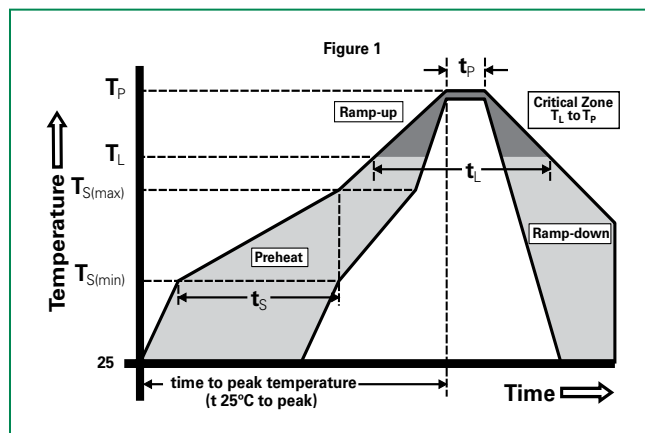
- The component must initially be in thermal equilibrium with -40°C  $\leq T_j \leq$  +150°C

### Thermal Considerations

Package	Symbol	Parameter	Value	Unit
 DO-15	$T_J$	Operating Junction Temperature Range	-40 to +150	°C
	$T_S$	Storage Temperature Range	-65 to +150	°C
	$R_{\theta JA}$	Thermal Resistance: Junction to Ambient	60	°C/W

### Soldering Parameters

Reflow Condition		Pb-Free assembly (see Fig. 1)
Pre Heat	- Temperature Min ( $T_{S(min)}$ )	+150°C
	- Temperature Max ( $T_{S(max)}$ )	+200°C
	- Time (Min to Max) ( $t_s$ )	60-180 secs.
Average ramp up rate (Liquidus Temp ( $T_L$ ) to peak)		3°C/sec. Max.
$T_{S(max)}$ to $T_L$ - Ramp-up Rate		3°C/sec. Max.
Reflow	- Temperature ( $T_L$ ) (Liquidus)	+217°C
	- Temperature ( $t_L$ )	60-150 secs.
Peak Temp ( $T_p$ )		+260(+0/-5)°C
Time within 5°C of actual Peak Temp ( $t_p$ )		30 secs. Max.
Ramp-down Rate		6°C/sec. Max.
Time 25°C to Peak Temp ( $T_p$ )		8 min. Max.
Do not exceed		+260°C



### Additional Information



Datasheet



Resources



Samples

### Physical Specifications

Lead Material	Copper Alloy
Terminal Finish	100% Matte-Tin Plated
Body Material	UL recognized epoxy meeting flammability classification V-0